

AO4414

N-Channel Enhancement Mode Field Effect Transistor



General Description

The AO4414 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance. Standard Product AO4414 is Pb-free (meets ROHS & Sony 259 specifications). AO4414L is a Green Product ordering option. AO4414 and AO4414L are electrically identical.

Features

 $V_{DS}(V) = 30V$

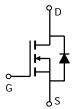
 $I_D = 8.5A \ (V_{GS} = 10V)$

 $R_{DS(ON)}$ < 26m Ω (V_{GS} = 10V)

 $R_{DS(ON)}$ < 40m Ω (V_{GS} = 4.5V)







Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V_{DS}	30	V			
Gate-Source Voltage		V_{GS}	±20	V			
Continuous Drain	T _A =25°C		8.5				
Current ^A	T _A =70°C	I_D	7.1	Α			
Pulsed Drain Current ^B		I _{DM}	50				
	T _A =25°C	D	3	W			
Power Dissipation	T _A =70°C	$-P_D$	2.1	VV			
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C			

Thermal Characteristics								
Parameter	Symbol	Тур	Typ Max Un					
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	31	40	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	κ_{θ} JA	59	75	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	16	24	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units		
STATIC PARAMETERS									
BV_{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		30			V		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V			0.004	1			
			T _J =55°C			5	μΑ		
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V				100	nA		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250\mu A$		1	1.9	3	V		
$I_{D(ON)}$	On state drain current	V _{GS} =4.5V, V _{DS} =5V		20			Α		
et4U.com		V_{GS} =10V, I_D =8.5A			20	26	S mΩ		
$R_{DS(ON)}$	Static Drain-Source On-Resistance		T _J =125°C		29.2	38	11152		
		V _{GS} =4.5V, I _D =5A			31	40	mΩ		
g _{FS}	Forward Transconductance	V_{DS} =5V, I_D =5A		10	17		S		
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.76	1	V		
Is	Maximum Body-Diode Continuous Curre	ırrent				4.3	Α		
DYNAMIC	PARAMETERS								
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			680	820	pF		
Coss	Output Capacitance				102		pF		
C _{rss}	Reverse Transfer Capacitance				77		pF		
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			3	3.6	Ω		
SWITCHI	NG PARAMETERS								
Q _g (10V)	Total Gate Charge	-V _{GS} =10V, V _{DS} =15V, I _D =8.5A			13.84	17	nC		
Q _g (4.5V)	Total Gate Charge				6.74	8.1	nC		
Q_{gs}	Gate Source Charge				1.84		nC		
Q_{gd}	Gate Drain Charge				3.32		nC		
t _{D(on)}	Turn-On DelayTime				4.5	6.5	ns		
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =1.8 Ω , R_{GEN} =3 Ω			4.2	6.3	ns		
$t_{D(off)}$	Turn-Off DelayTime				20.1	30	ns		
t _f	Turn-Off Fall Time				4.9	7.5	ns		
t _{rr}	Body Diode Reverse Recovery Time	I _F =8.5A, dI/dt=100A/μs			17.2	21	ns		
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =8.5A, dI/dt=100A/μs			8.6	10	nC		

A: The value of R_{0JA} is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

Rev 5: June 2005

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

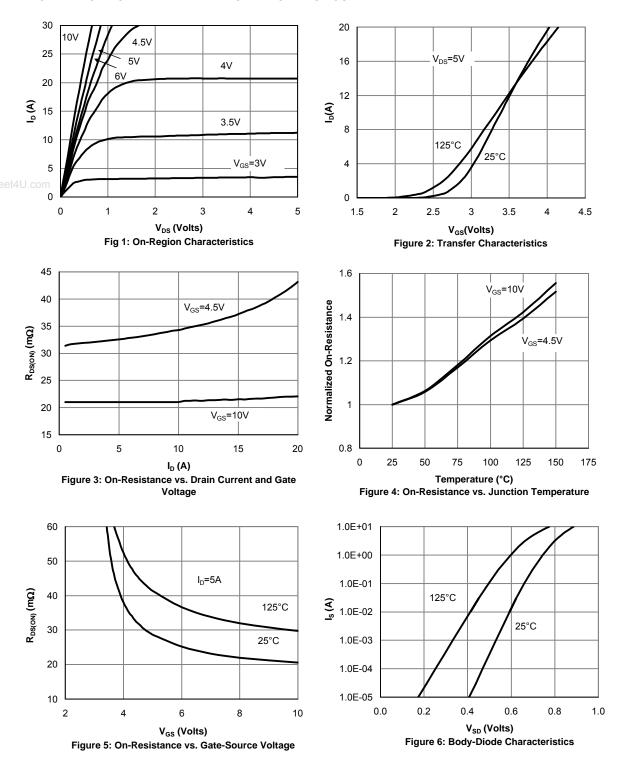
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

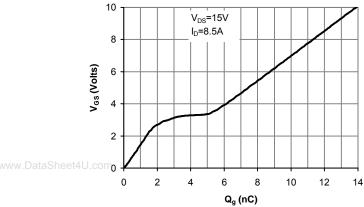


Figure 7: Gate-Charge Characteristics

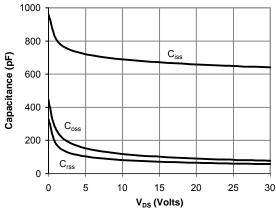


Figure 8: Capacitance Characteristics

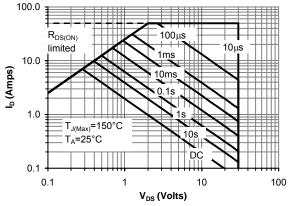


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

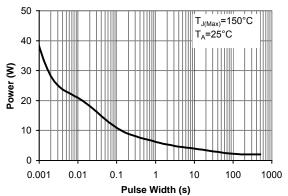


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

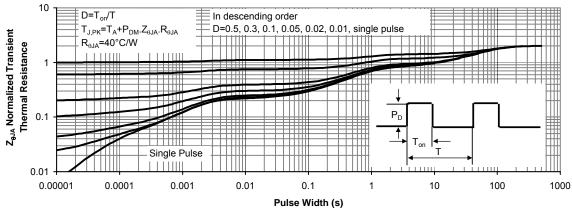


Figure 11: Normalized Maximum Transient Thermal Impedance